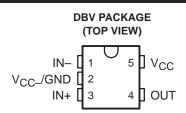
SLVS238C - AUGUST 1999 - REVISED AUGUST 2003

- Equivalent to Single Version of Industry-Standard LM339, LM393
- Single Supply or Dual Supplies
- Wide Range of Supply Voltage ... 2 V to 36 V
- Low Supply-Current Drain Independent of Supply Voltage . . . 0.4 mA Typ
- Low Input Bias Current . . . 25 nA Typ
- Low Input Offset Voltage . . . 2 mV Typ
- Common-Mode Input Voltage Range Includes Ground
- Differential Input Voltage Range Equal to Maximum-Rated Supply Voltage . . . ±36 V
- Low Output Saturation Voltage
- Output Compatible With TTL, MOS, and CMOS



description/ordering information

This device consists of a single voltage comparator that is designed to operate from a single power supply over a wide range of voltages. Operation from dual supplies also is possible if the difference between the two supplies is 2 V to 36 V and V_{CC} is at least 1.5 V more positive than the input common-mode voltage. Current drain is independent of the supply voltage. The output can be connected to other open-collector outputs to achieve wired-AND relationships.

ORDERING INFORMATION

TA	V _{IO} (max) at 25°C	PACKAGE [†]		ORDERABLE PART NUMBER	TOP-SIDE MARKING‡
-40°C to 85°C	5 mV	SOT-23 (DBV)	Reel of 3000	TL331IDBVR	T41
			Reel of 250	TL331IDBVT	' ''_

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

logic diagram



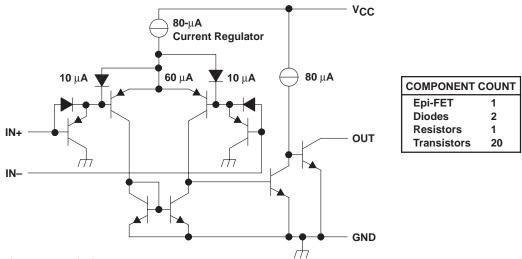


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[‡] DBV: The actual top-side marking has one additional character that designates the assembly/test site.

schematic



Current values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC} (see Note 1)	
Differential input voltage, V _{ID} (see Note 2)	
Input voltage range, V _I (either input)	0.3 V to 36 V
Output voltage, VO	
Output current, IO	20 mA
Duration of output short-circuit to ground (see Note 3)	Unlimited
Package thermal impedance, θ _{JA} (see Notes 4 and 5)	206°C/W
Operating virtual junction temperature, T _J	150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C
Storage temperature range, T _{stq}	−65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values, except differential voltages, are with respect to the network ground.
 - 2. Differential voltages are at IN+ with respect to IN-.
 - 3. Short circuits from outputs to $V_{\hbox{\footnotesize CC}}$ can cause excessive heating and eventual destruction.
 - Maximum power dissipation is a function of T_J(max), θ_{JA}, and T_A. The maximum allowable power dissipation at any allowable ambient temperature is P_D = (T_J(max) T_A)/θ_{JA}. Operating at the absolute maximum T_J of 150°C can impact reliability.
 - 5. The package thermal impedance is calculated in accordance with JESD 51-7.



SLVS238C - AUGUST 1999 - REVISED AUGUST 2003

electrical characteristics at specified free-air temperature, $V_{CC} = 5 \text{ V}$ (unless otherwise noted)

	PARAMETER	TEST (CONDITIONS	T _A †	MIN	TYP	MAX	UNIT
\/10 In	Input offeet voltege	V _{CC} = 5 V to 30 V, V _O = 1.4 V,		25°C		2	5	mV
V _{IO} Input offset voltage		VIC = VIC(min)		-40°C to 85°C			9	IIIV
lio.	Input offeet current	Vo = 1.4.V		25°C		5	50	nA
I _{IO} Input offset current		V _O = 1.4 V		-40°C to 85°C			250	HA
I _{IB} Input bias current		Vo - 1.4.V		25°C		-25	-250	nA
IB	input bias current	V _O = 1.4 V		-40°C to 85°C			-400	TIA
Common-mode				25°C	0 to V _{CC} -1.5			V
VICR	VICR input voltage range‡			-40°C to 85°C	0 to V _{CC} -2			v
AVD	Large-signal differential voltage amplification	$V_{CC} = 15 \text{ V}, V_{O}$ $R_{L} \ge 15 \text{ k}\Omega \text{ to } V_{O}$	= 1.4 V to 11.4 V,	25°C	50	200		V/mV
I _{OH} Hi	High-level output current	V _{OH} = 5 V,	V _{ID} = 1 V	25°C		0.1	50	nA
		V _{OH} = 30 V,	V _{ID} = 1 V	-40°C to 85°C			1	μА
V _{OL} L	Low-level output voltage	I _{OL} = 4 mA,	\/ 1\/	25°C		150	400	mV
			$V_{ID} = -1 V$	-40°C to 85°C			700	
l _{OL}	Low-level output current	$V_{OL} = 1.5 V$,	V _{ID} = 1 V	25°C	6			mA
ICC	Supply current	R _L = ∞,	$V_{CC} = 5 V$	25°C		0.4	0.7	mA

[†] All characteristics are measured with zero common-mode input voltage, unless otherwise specified.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

PARAMETER	TEST CONDITIONS			UNIT
Response time	R _L connected to 5 V through 5.1 k Ω ,	100-mV input step with 5-mV overdrive	1.3	μs
	C _L = 15 pF§ (see Note 6)	TTL-level input step	0.3	

§ C_L includes probe and jig capacitance.

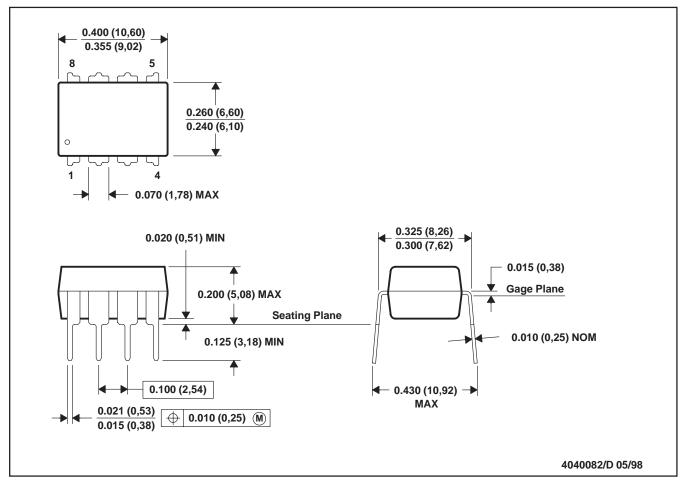
NOTE 6: The response time specified is the interval between the input step function and the instant when the output crosses 1.4 V.



[‡] The voltage at either input or common-mode should not be allowed to go negative by more than 0.3 V. The upper end of the common-mode voltage range is V_{CC+} – 1.5 V, but either or both inputs can go to 30 V without damage.

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE



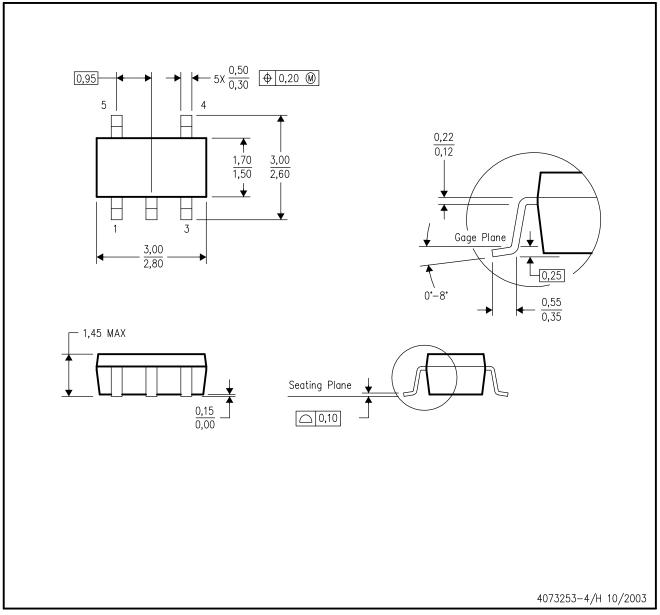
NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001

For the latest package information, go to http://www.ti.com/sc/docs/package/pkg_info.htm

DBV (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

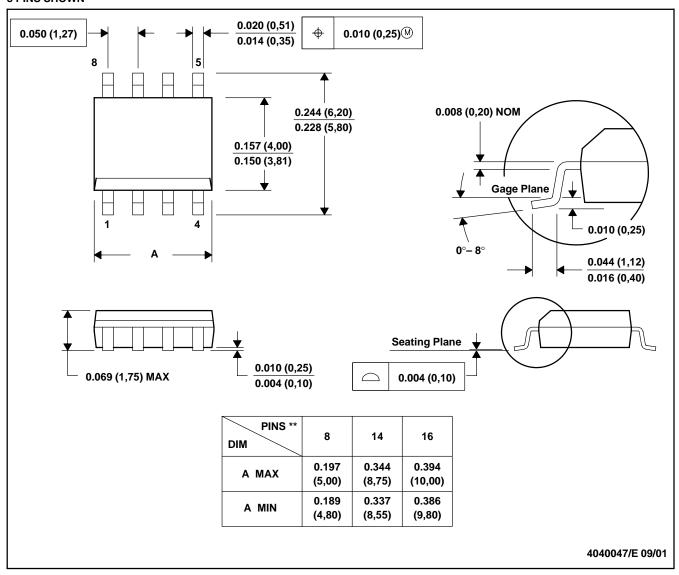
- All linear dimensions are in millimeters.
- This drawing is subject to change without notice.
- C. Body dimensions do not include mold fla D. Falls within JEDEC MO—178 Variation AA. Body dimensions do not include mold flash or protrusion.



D (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

8 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012

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